November 2013



FGH40N60SFD 600 V, 40 A Field Stop IGBT

Features

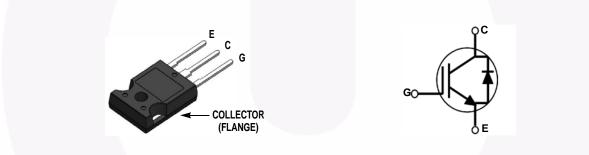
- High Current Capability
- Low Saturation Voltage: V_{CE(sat)} = 2.3 V @ I_C = 40 A
- High Input Impedance
- Fast Switching
- RoHS Compliant

Applications

 Solar Inverter, UPS, Welder, PFC, Microwave Oven, Telecom, ESS

General Description

Using novel field stop IGBT technology, Fairchild's field stop IGBTs offer the optimum performance for solar inverter, UPS, welder, microwave oven, telecom, ESS and PFC applications where low conduction and switching losses are essential.



Absolute Maximum Ratings

Symbol	Description		Ratings	Unit
V _{CES}	Collector to Emitter Voltage		600	V
V _{GES}	Gate to Emitter Voltage		± 20	V
I _C	Collector Current	@ T _C = 25°C	80	А
·	Collector Current	@ T _C = 100°C	40	A
I _{CM (1)}	Pulsed Collector Current	@ T _C = 25°C	120	А
P _D	Maximum Power Dissipation	@ T _C = 25°C	290	W
·D	Maximum Power Dissipation	@ T _C = 100 ^o C	116	W
TJ	Operating Junction Temperature		-55 to +150	°C
T _{stg}	Storage Temperature Range		-55 to +150	°C
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seco	nds	300	°C

Notes:

1: Repetitive rating: Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction to Case	-	0.43	°C/W
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case	-	1.45	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	-	40	°C/W

Part Number Top Mark Pack		Packa	age Packing Method		Ree	el Size	Tape Width		Quantity	
FGH40N60SFDTU FGH40N60SFD TO-24		7	Tube	N/A		N/A		30		
Electric	al Cha	racteristics of	f the lo	GB.	$T_{\rm C} = 25^{\circ} \rm C$ unless otherwis	e noted				
Symbol		Parameter			Test Conditions	5	Min.	Тур.	Max.	Unit
Off Charac	teristics									
BV _{CES}	Collector	r to Emitter Breakdowr	Voltage	V _{GE}	= 0 V, I _C = 250 μA		600	-	-	V
$\frac{\Delta BV_{CES}}{\Delta T_{J}}$	Tempera Voltage	ture Coefficient of Bre	akdown	V _{GE}	_E = 0 V, I _C = 250 μA		-	0.6	-	V/ºC
I _{CES}	Collector	r Cut-Off Current		V _{CE} = V _{CES} , V _{GE} = 0 V		-	-	250	μA	
I _{GES}	G-E Lea	kage Current		-	$= V_{GES}, V_{CE} = 0 V$		-	- >	±400	nA
On Charac	teristics				-					
V _{GE(th)}	1	eshold Voltage		ا _د =	= 250 μA, V _{CE} = V _{GE}		4.0	5.0	6.5	V
GE(iii)					40 A, V _{GE} = 15 V		-	2.3	2.9	V
V _{CE(sat)}	Collector	ector to Emitter Saturation Voltage			$I_{C} = 40 \text{ A}, V_{GE} = 15 \text{ V},$ $T_{C} = 125^{\circ}\text{C}$			2.5	-	V
Dynamic C C _{ies}		stics pacitance					-	2110	-	pF
C _{oes}	Output C	Capacitance			$V_{CE} = 30 V, V_{GE} = 0 V,$		-	200	-	pF
C _{res}	Reverse	rse Transfer Capacitance		f = 1 MHz		-	60	-	pF	
Switching	Characte	ristics							1	
t _{d(on)}	Turn-On	Delay Time					-	25	-	ns
t _r	Rise Tim	ie		1			-	42	-	ns
t _{d(off)}	Turn-Off	Delay Time		Vcc	_c = 400 V, I _C = 40 A,		-	115	-	ns
t _f	Fall Time	e		R_{G}	$R_G = 10 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 25^{\circ}C$		-	27	54	ns
Eon	Turn-On	Switching Loss		Ind			-	1.13	-	mJ
E _{off}	Turn-Off	Switching Loss		1			-	0.31	-	mJ
E _{ts}	Total Sw	itching Loss		1			-	1.44	-	mJ
t _{d(on)}	Turn-On	Delay Time					-	24	-	ns
t _r	Rise Tim	ie		1			-	43	-	ns
t _{d(off)}	Turn-Off	Delay Time		Vcc	_c = 400 V, I _C = 40 A,		-	120	-	ns
t _f	Fall Time	9			= 10 Ω, V_{GE} = 15 V,		-	30	-	ns
E _{on}	Turn-On	Switching Loss		Inductive Load, T _C = 125°C		<i>.</i>	-	1.14	-	mJ
E _{off}	Turn-Off	Switching Loss					-	0.48	-	mJ
E _{ts}	Total Sw	itching Loss		L			-	1.62	-	mJ
Qg	Total Ga	te Charge					-	120	-	nC
Q _{ge}	Gate to I	Emitter Charge		V _{CE}	= 400 V, I _C = 40 A,		-	14	-	nC
Q _{gc}	<u> </u>	Collector Charge		¶ [™] GE	V _{GE} = 15 V		-	58	-	nC

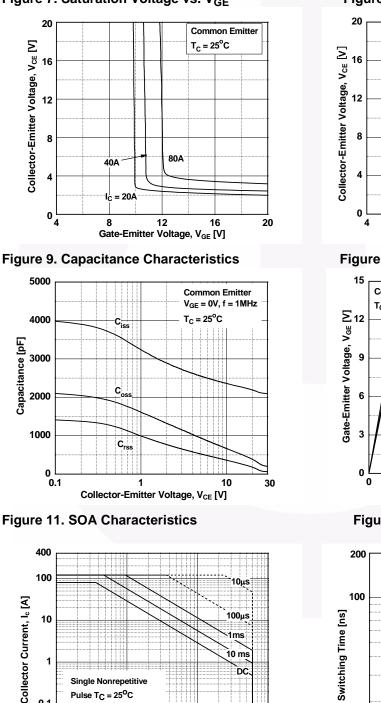
FGH40N
60SFD —
600 V, 40
) A Field
Stop IGB

Symbol	Parameter	Test Condition	าร	Min.	Тур.	Max	Unit
V _{FM}	Diode Forward Voltage	I _E = 20 A	$T_C = 25^{\circ}C$	-	1.95	2.6	V
		F = 20 /	$T_{\rm C} = 125^{\rm o}{\rm C}$	-	1.85	-	, v
t	Diode Reverse Recovery Time		$T_{\rm C} = 25^{\rm o}{\rm C}$	-	45	-	ns
۲r		I _F =20 A, di _F /dt = 200 A/μs	$T_{\rm C} = 125^{\rm o}{\rm C}$	-	140	-	
Q _{rr}	Diode Reverse Recovery Charge	$F = 20 A$, $dF/dt = 200 A/\mu S$	$T_{\rm C} = 25^{\rm o}{\rm C}$	-	75	-	nC
≪rr			$T_{\rm C} = 125^{\rm o}{\rm C}$	-	375	-	

FGH40N60SFD — 600 V, 40 A Field Stop IGBT

Typical Performance Characteristics Figure 1. Typical Output Characteristics Figure 2. Typical Output Characteristics 120 120 T_C = 25^oC T_C = 125^oC 20V 200 15V 100 15V 100 120 Collector Current, I_c [A] Collector Current, I_c [A] 80 80 12V 60 60 10V 40 40 10V 20 20 $V_{GE} = 8V$ V_{GE} = 8V 0 0 0.0 1.5 3.0 4.5 6.0 0.0 3.0 4.5 6.0 1.5 Collector-Emitter Voltage, V_{CE} [V] Collector-Emitter Voltage, V_{CE} [V] Figure 3. Typical Saturation Voltage **Figure 4. Transfer Characteristics Characteristics** 120 80 Common Emitter Common Emitter $V_{CE} = 20V$ $V_{GE} = 15V$ $T_{C} = 25^{\circ}C$ — $T_{C} = 25^{\circ}C$ — Collector Current, I_c [A] Collector Current, I_c [A] 00 05 09 09 T_C = 125^oC ... T_C = 125^oC 80 40 0 0 10 0 1 2 3 Collector-Emitter Voltage, V_{CE} [V] 6 12 13 8 Gate-Emitter Voltage, V_{GE} [V] Figure 5. Saturation Voltage vs. Case Figure 6. Saturation Voltage vs. V_{GE} **Temperature at Variant Current Level** 4.0 20 Common Emitte Common Emitter V_{GE} = 15V Collector-Emitter Voltage, V_{CE} [V] Collector-Emitter Voltage, V_{CE} [V] $T_{C} = -40^{\circ}C$ 3.5 80A 16 3.0 12 2.5 40A 8 2.0 80A $I_{\rm C} = 20A$ 4 1.5 I_C = 20A 0 ∟ 4 1.0 └ 25 50 75 100 125 20 8 12 16 Gate-Emitter Voltage, V_{GE} [V] Case Temperature, T_C [°C]

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100µs

1ms 10 ms

DC

1000

100

Collector-Emitter Voltage, V_{CE} [V]

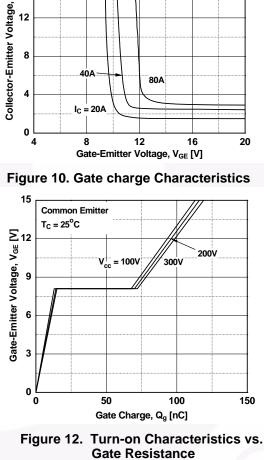
Typical Performance Characteristics

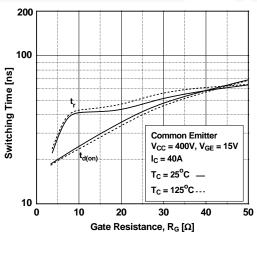
Figure 7. Saturation Voltage vs. V_{GE}

Figure 8. Saturation Voltage vs. V_{GE}

Common Emitter

 $T_C = 125^{\circ}C$





10

1

0.1

0.01

1

Single Nonrepetitive

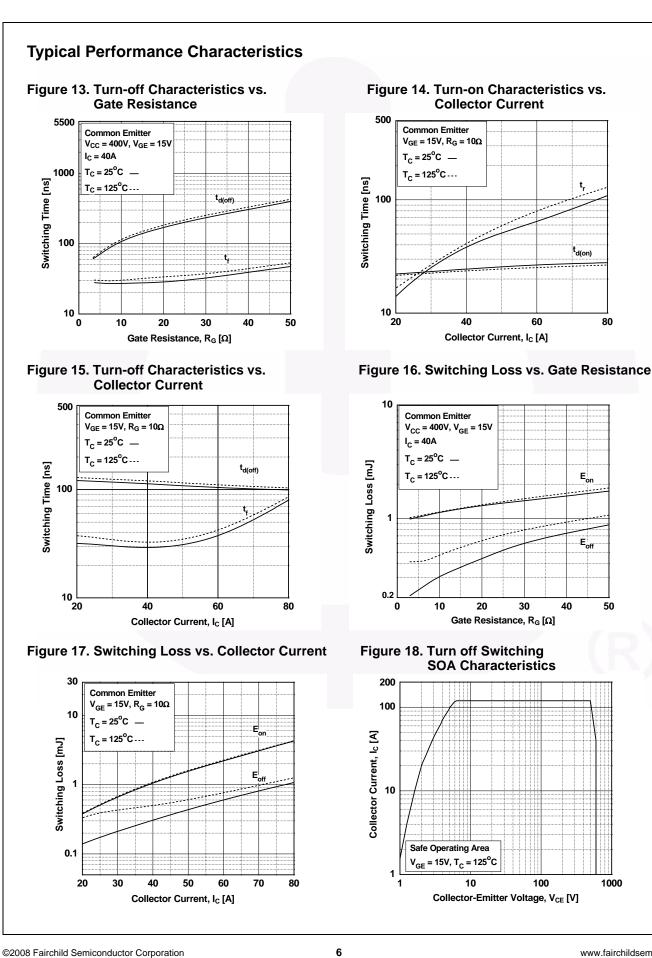
Curves must be derated

10

linearly with increase in temperature

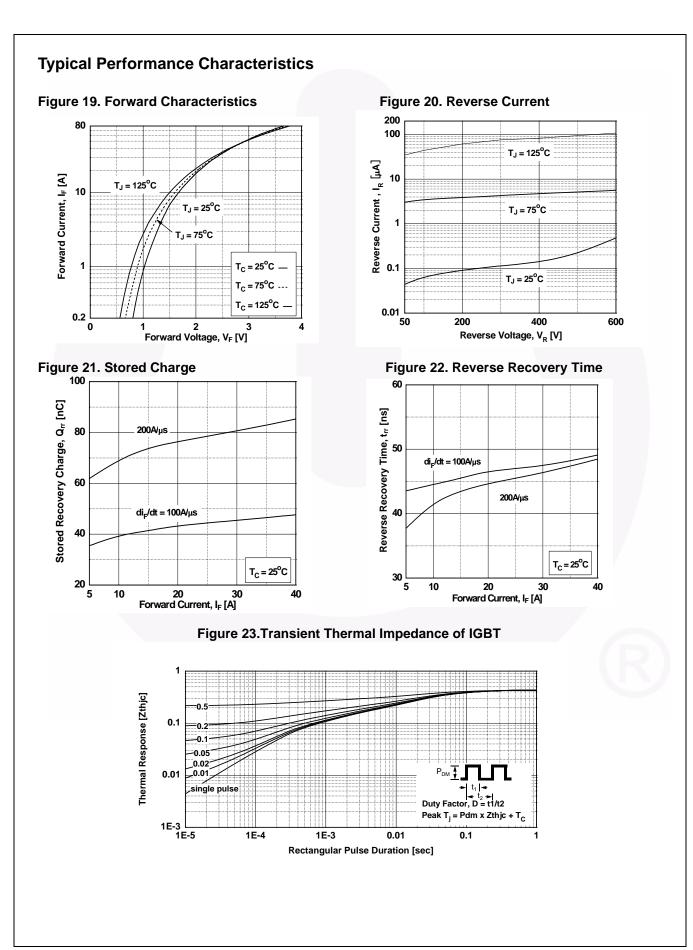
Pulse T_C = 25^oC

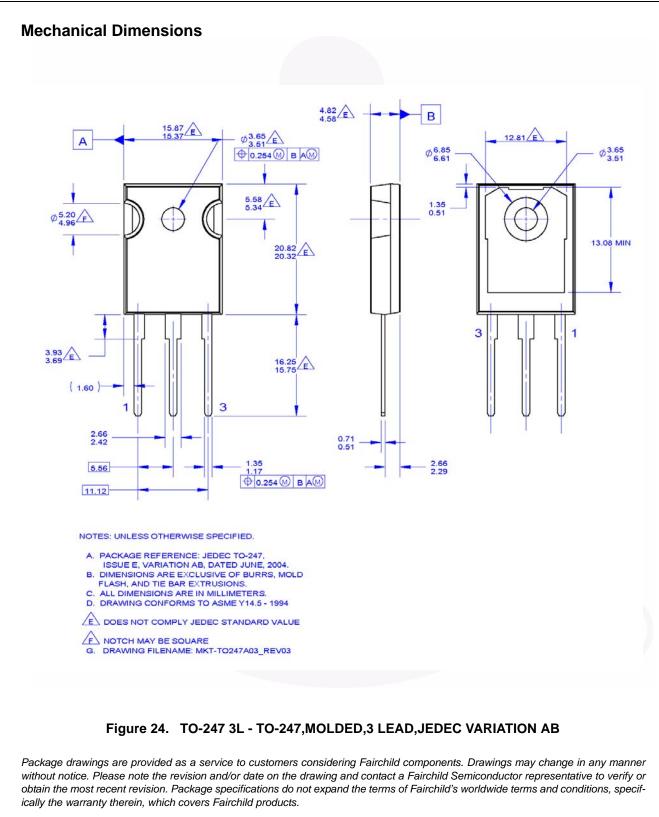
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FGH40N60SFD —

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